

RESPONSE UNDER 37 CFR 1.116  
EXPEDITED PROCEDURE  
EXAMINING GROUP 2811

PATENT APPLICATION  
Docket No.: 9898-208  
Client Ref. No.: SS-15400-US-RCE-RCE

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Ki-Won CHOI

Serial No.: 10/055,266

Examiner: Nadav, Ori

Filed: January 22, 2002

Group Art Unit: 2811

Confirmation No.: 6747

For: SEMICONDUCTOR PACKAGE HAVING CHANGED SUBSTRATE  
DESIGN USING SPECIAL WIRE BONDING

Date: January 10, 2007

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT AFTER FINAL REJECTION UNDER 37 CFR 1.116**

Responsive to the Final Office Action, Paper No. 20061001, dated October 11, 2006,  
please amend the application as follows.

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Drawings** begin on page 3 of this paper and include both an  
attached replacement sheet and an annotated sheet showing changes.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 4  
of this paper.

**Remarks/Arguments** begin on page 7 of this paper.

An **Appendix** including amended drawing figures is attached following page 10 of this paper.